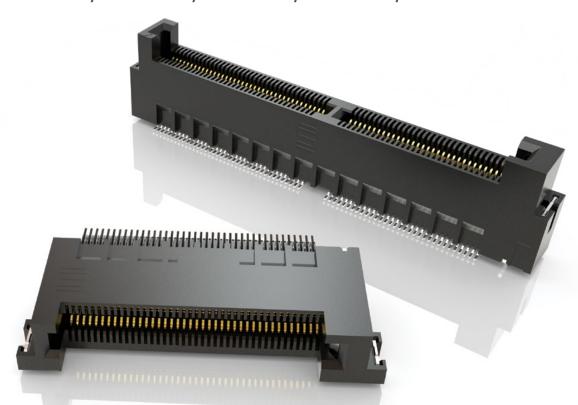
MICRO EDGE CARD SYSTEMS

0.50 mm, 0.635 mm, 0.80 mm, 1.00 mm, 1.27 mm, 2.00 mm PITCH



FEATURES & BENEFITS

- Up to 56 Gbps PAM4
- PCI Express® 4.0 (MEC5 Series)
- Solutions for (1.60 mm) .062" and (2.36 mm) .093" thick cards
- Choice of pitch: 0.50 mm, 0.635 mm, 0.80 mm, 1.00 mm, 1.27 mm, 2.00 mm
- Vertical, right-angle and edge mount orientations
- Available in surface mount and through-hole



Staggered press-fit tails (MEC8-VP)



Justification beam ensures card and body are flush (MEC5)

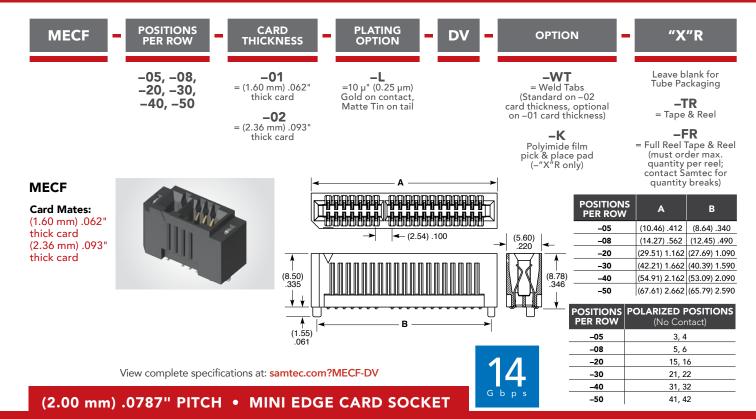
KEY SPECIFICATIONS

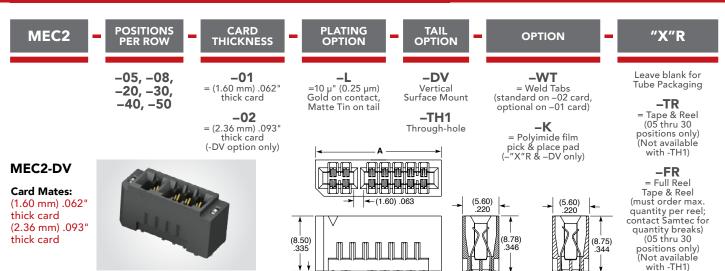
SERIES	PITCH	TOTAL POSITIONS	INSULATOR MATERIAL	CONTACT MATERIAL	OPERATING TEMP RANGE	CURRENT RATING	VOLTAGE RATING	LEAD-FREE SOLDERABLE
MEC5	0.50 mm	60-200	Black LCP	Phosphor Bronze	-55 °C to +125 °C	1.5 A (2 pins)	125 VAC	Yes
MEC6	0.635 mm	20-140	Black LCP	Phosphor Bronze	-55 °C to +125 °C	2.4 A (2 pins)	185 VAC	Yes
MEC8	0.80 mm	20-140	Black LCP	Phosphor Bronze	-55 °C to +125 °C	2.3 A (2 pins)	180 VAC	Yes
MEC1	1.00 mm	20-140	Black LCP	Phosphor Bronze	-55 °C to +125 °C	2.2 A (2 pins)	250 VAC	Yes
MECF	1.27 mm	10-100	Black/Natural LCP	BeCu	-55 °C to +125 °C	3.5 A (2 pins)	280 VAC	Yes
MEC2	2.00 mm	10-100	Black/Natural LCP	BeCu	-55 °C to +125 °C	3.5 A (2 pins)	235 VAC	Yes





(1.27 mm) .050" PITCH • MINI EDGE CARD SOCKET





MEC2-TH

Card Mates: (1.60 mm) .062" thick card



Note:

Some sizes, styles and options are non-standard, non-returnable.

POSITIONS PER ROW	A	В
-05	(13.40) .528	(11.50) .453
-08	(19.40) .764	(17.50) .689
-20	(43.40) 1.709	(41.50) 1.634
-30	(63.40) 2.496	(61.50) 2.421
-40	(83.40) 3.283	(81.50) 3.209
-50	(103.40) 4.071	(101.50) 3.996

-TH1

-DV

POSITIONS PER ROW	POLARIZED POSITIONS (No Contact)
-05	3, 4
-08	5, 6
-20	15, 16
-30	21, 22
-40	31, 32
-50	41, 42

View complete specifications at: samtec.com?MEC2-DV & samtec.com?MEC2-TH

(1.55) .061

Mouser Electronics

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MECF-20-02-L-DV-NP-WT